



Customer Information Notification

2018080071

Issue Date: 16-Sep-2018
Effective Date: 17-Sep-2018

Here's your personalized quality information concerning products Digi-Key purchased from NXP.
For detailed information we invite you to view this notification online



QUALITY

Change Category

Wafer Fab Process

Wafer Fab Materials

Wafer Fab Location

Firmware

Assembly Process

Assembly Materials

Assembly Location

Other

Product Marking

Mechanical Specification

Packing/Shipping/Labeling Equipment

Test Location

Test Process

Test Equipment

Design

Errata

Electrical spec./Test coverage

eXtreme Switch Data Sheet Updates:
MC07XS3200, MC09XS3400,
MC10XS3412, MC10XS3425,
MC10XS3435, MC15XS3400, and
MC35XS3400

Description

NXP Semiconductors announces data sheet updates for the eXtreme Switch products associated with this notification. The revision history included in the updated documents provides a detailed description of the changes. Changes are summarized below.

Data Sheet Changes:

1. Corrected TOLLED values in Table: Dynamic electrical characteristics
2. Updated Openload detection in ON state for LED (added clarification for the usage of openload LED function and changed D[6:0]=7F to D[7:0]=FF)

The new eXtreme Switch data sheets, summarized below, can be found attached to this notification, and at the NXP.com product family webpage:

<https://www.nxp.com/products/power-management/load-switches-and-drivers/high-side-switches/12v-automotive-exterior-lighting-multi-extreme-switch:MC12XS3>

MC07XS3200 Rev 5.0
MC09XS3400 Rev 5.0
MC10XS3412 Rev 13.0
MC10XS3425 Rev 6.0
MC10XS3435 Rev 12.0

MC15XS3400 Rev 11.0
MC35XS3400 Rev 11.0

Corresponding ZVEI Delta Qualification Matrix ID: SEM-DS-02

Reason

The data sheets have been updated to correct errors and provide additional technical clarification on some device features.

Identification of Affected Products

Product identification does not change

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No impact on form, fit, function, reliability or quality.

Data Sheet Revision

A new datasheet will be issued

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

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NXP Quality Management Team.

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Affected Part Numbers

MC10XS3425EK

MC09XS3400AFK